ACEE 2027

2027 4th Asia Conference on Electronics Engineering



Nowadays, we are surrounded by electronic devices in our everyday lives, such as, phones, computer, etc. The electronic devices have become an indispensable part of our lives. At the situation, 2027 4th Asia Conference on Electronics Engineering (ACEE 2027), sponsored by the University of Electronic Science and Technology of China and hosted by the School of Integrated Circuit Science and Engineering (Exemplary School of Microelectronics), University of Electronic Science and Technology of China, will be held in Chengdu, China during July 9-11, 2027. It aims to bring together researchers in the related areas, which devoted their work to push the development of electronics engineering.

The conference topics include several tracks, such as, Microelectronics and Nanoelectronic Devices, Microelectronics and Nanoelectronic Devices, Microelectronics and Nanoelectronic Devices, Medical Electronics Technologies and Devices, etc. ACEE 2027 conference seeks papers presenting significant and novel research results on emerging electronics engineering and its applications. We especially encourage submissions that present novel experimentation, creative use of electronic technologies, and new insights made possible using analysis.

July 9–11, 2027 | Chengdu, China

Sponsored by 电子科技大学 University of Electronic Science and Technology of China

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www.acee.net

CALL FOR PAPERS TOPICS

Track 1. Microelectronics and Nanoelectronic Devices
Track 2. Integrated Circuit Design and Manufacturing
Track 3. Optoelectronics and Image Sensing Technology
Track 4. Electromagnetic Theory and Electronic Communication Device Design
Track 5. Medical Electronics Technologies and Devices
Track 6. Embedded Systems and Control Technologies
Track 7. Intelligent Sensing and MEMS Technologies
Track 8. Quantum Electronics and Quantum Computing
Track 9. Electronic System Security and AI Applications

More Details: https://www.acee.net/topics.html

IMPORTANT DATES

Full Paper & Abstract Submission Deadline: February 15, 2027
Notification of Review Results: March 15, 2027
Final Manuscript Submission & Conference Registration Deadline: March 31, 2027
Conference Held: July 9–11, 2027

SUBMISSION GUIDELINES

★ **Official Language:** All manuscripts and presentations must be in English.
★ **Manuscript Templates:**
Single-column Word Template:
https://www.acee.net/conference-template-letter.docx
Two-column LaTeX Template: conference-latex-template.zip
★ **Submission Channels:**
Online Submission System:
https://www.zmeeting.org/submission/ACEE2027
Email Submission: acee_conference@126.com. Please set your email subject as "Submission-ACEE 2027-Full Paper/ Abstract".
★ **Submission Confirmation:**
Within 2 working days after submission, the conference secretary will send an email with the assigned Paper ID.
★ **Submission Types:**
Authors may submit abstracts or full papers via the online system. Only accepted full papers will be included in the conference proceedings for publication. Please contact the conference secretary by phone or email if you encounter any submission issues.

For more submission guidelines: https://ceta.net/sub.html

PUBLICATION

All papers will be sent to 2-3 peer-reviewers for reviewing. After a careful reviewing process, all accepted papers after proper registration and presentation, will be published into ACEE 2027 conference proceedings.

For detailed publication history, please visit:
https://www.acee.net/index.html

ORAL PRESENTATION GUIDELINES

1、All authors shall deliver oral presentations in English.
2、Each presentation lasts 15 minutes, including 2–3 minutes for Q&A.
3、Laptops and presentation equipment will be provided on site; presenters need to prepare PPT in advance.
4、One excellent presentation will be selected from each session, and the presenter will receive an official excellent presentation certificate.

CONFERENCE SCHEDULE

July 9: Online Test, On-site Registration and Material Collection
July 10: Opening Ceremony, Keynote Speeches, Invited Speeches, Author Presentations, and Banquet
July 11: Invited Speeches and Author Presentations

For more details: https://www.acee.net/pro.html

CONTACT INFORMATION

Conference Secretary: Ms. Thalia Chen
Email: acee_conference@126.com
Tel: 19182091916

ACEE 2027



2027 年第四届亚洲电子工程会议

如今，日常生活中各类电子设备随处可见，例如手机、计算机等。电子设备已经成为我们生活中不可或缺的组成部分。在此背景下，由电子科技大学主办、电子科技大学集成电路科学与工程学院承办（示范性微电子学院）的2027　年第四届亚洲电子工程会议（ACEE　2027）将于 2027 年 7 月 9–11 日在中国成都举办。会议旨在促进电子工程领域内的交流与合作，为相关研究领域内的专业人士、学者和研究人员提供专业的学术交流平台。届时欢迎学术界人士踊跃投稿，与会交流。

会议设置多个专题方向，包括微电子与纳米电子器件、医疗电子技术与器件等。ACEE 2027 面向新兴电子工程及其应用领域，征集具有重要价值与创新性研究成果的论文。会议特别鼓励提交包含新颖实验、电子技术创新应用以及基于分析得到全新见解的研究稿件。

2027 年 7 月 9 日 - 11 日 | 中国·成都

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征稿主题

主题 1. 微电子与纳米电子器件
主题 2. 集成电路设计与制造
主题 3. 光电子与图像传感技术
主题 4. 电磁理论与电子通信器件设计
主题 5. 医学电子技术与器件
主题 6. 嵌入式系统与控制技术
主题 7. 智能传感与MEMS技术
主题 8. 量子电子与量子计算
主题 9. 电子系统安全与人工智能应用

更多征稿主题:
https://www.acee.net/topics.html

关键时间节点

全文 / 摘要投稿截止：2027 年 2 月 15日
录用通知时间：2027 年 3 月 15 日
终稿提交 + 会议注册截止：2027 年 3 月 31 日
会议时间：2027 年 7 月 9 - 11 日

投稿规范

★官方语言：论文撰写、现场汇报均使用英语
★稿件模板：
单栏 Word 模板：https://www.acee.net/conference-template-letter.docx
双栏 LaTeX 模板：conference-latex-template.zip
★投稿渠道：
官方在线投稿系统 https://www.zmeeting.org/submission/ACEE2027
投稿至邮箱：acee_conference@126.com　请将邮件主题命名为"Submission-ACEE 2027-Full Paper/ Abstract".
★投稿回执：稿件提交后 2 个工作日内，会议秘书将通过邮箱发送邮件分配论文编号
★投稿类型：有意向的作者可通过电子投稿系统提交摘要或全文。只有被接受的全文才能被录用到论文集中进行出版。如您投稿中遇到任何问题，请电话或者邮件联系会议秘书。

更多投稿规范请访问:
https://ceta.net/sub.html

会议出版

提交至ACEE　2027的论文，经过同行评议程序，被录用的论文将出版于 ACEE 2027会议论文集。
注意：如不愿意出版全文，可以只投递摘要，进行口头或者海报报告。出版原则：杜绝抄袭，一切抄袭的文章，将不会被接收和录用。

有关出版历史的详细信息，请访问:
https://www.acee.net/index.html

口头汇报要求

所有作者需使用英文完成口头汇报;
单篇论文汇报总时长 15 分钟，包含 2–3 分钟问答环节;
会场提供电脑与演示设备，汇报人需提前准备 PPT;
每个分会场评选 1 份优秀汇报，为作者颁发官方优秀演讲证书。

会议日程

7月 9 日：在线测试、会议签到及材料领取
7 月 10 日：开幕式、主旨报告、特邀报告、作者报告、晚宴
7 月 11 日：特邀报告、作者报告

如需了解更多信息，请访问:
https://www.acee.net/pro.html

联系方式

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